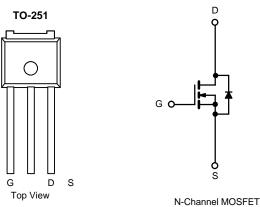


### CMU04N03L-VB Datasheet

N-Channel 30-V (D-S) MOSFET

**PRODUCT SUMMARY** V<sub>DS</sub> (V)  $R_{DS(on)}(\Omega)$ I<sub>D</sub> (A)<sup>a, e</sup> Q<sub>g</sub> (Typ) 0.0035 at V<sub>GS</sub> = 10 V 100 30 95nC 0.0045 at  $V_{GS}$  = 4.5 V 97



#### **FEATURES**

- Trench Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested •
- Compliant to RoHS Directive 2011/65/EU

#### **APPLICATIONS**

- OR-ing
- Server
- DC/DC

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C		100 <sup>a, e</sup>	A	
	T <sub>C</sub> = 70 °C		95 <sup>e</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	35 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		26 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	197	_	
Avalanche Current Pulse	nche Current Pulse		39		
Single Pulse Avalanche Energy		E <sub>AS</sub>	94.8	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1-	90 <sup>a, e</sup>		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.13 <sup>b, c</sup>	— A	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		250 <sup>a</sup>		
	T <sub>C</sub> = 70 °C	PD	175	w	
	T <sub>A</sub> = 25 °C	۲D	3.75 <sup>b, c</sup>	v	
	T <sub>A</sub> = 70 °C		2.63 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.5	0.6	0/10	

Notes:

a. Based on  $T_C = 25 \text{ °C}$ . b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 sec. d. Maximum under steady state conditions is 90 °C/W.

e. Calculated based on maximum junction temperature. Package limitation current is 90 A.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		35		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = 250 μA		- 7.5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	90			А
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 38.8 A		0.0035		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 37 \text{ A}$	0.0045			Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 38.8 A		160		S
Dynamic <sup>b</sup>						•
Input Capacitance	C <sub>iss</sub>			3000		
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		710		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			170		
Tatal Cata Charge	Q <sub>g</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 38.8 A		171	257	nC
Total Gate Charge	Qg			81.5	123	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 28.8 A		34		
Gate-Drain Charge	Q <sub>gd</sub>			29		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.4	2.1	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			18	27	
Rise Time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = 15 \; V,  R_{L} = 0.625 \; \Omega \\ I_{D} \cong 24 \; A,  V_{GEN} = 10 \; V,  R_{g} = 1 \; \Omega \end{array}$		11	17	
Turn-Off Delay Time	t <sub>d(off)</sub>			70	105	
Fall Time	t <sub>f</sub>			10	15	
Turn-On Delay Time	t <sub>d(on)</sub>			55	83	ns
Rise Time	t <sub>r</sub>	$V_{\text{DD}} = 15 \text{ V}, \text{ R}_{\text{L}} = 0.67 \Omega$ $\text{I}_{\text{D}} \cong 22.5 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		180	270	-
Turn-Off Delay Time	t <sub>d(off)</sub>			55	83	
Fall Time	t <sub>f</sub>	1		12	18	
Drain-Source Body Diode Characteristic	s					•
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			120	^
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				120	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 22 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			52	78	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		70.2	105	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$r_F = 20 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{s}, \text{ 1}\text{J} = 25 \text{ °C}$		27		
Reverse Recovery Rise Time	t <sub>b</sub>			25		ns

Notes:

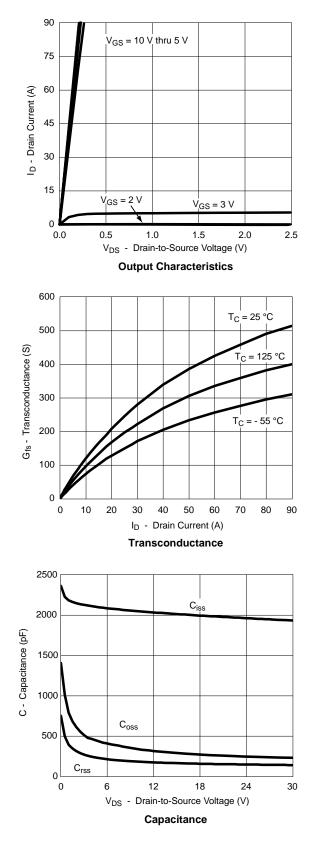
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2$  %.

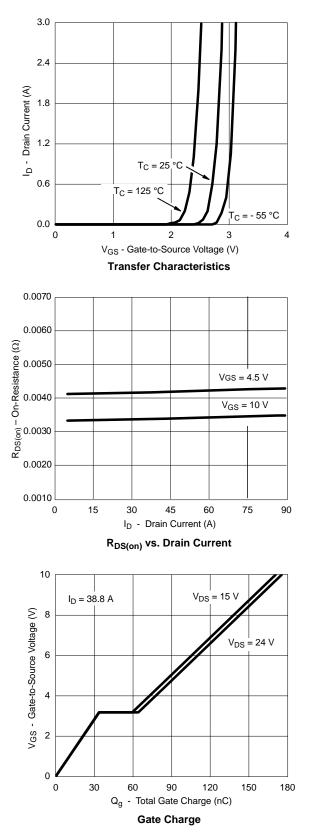
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



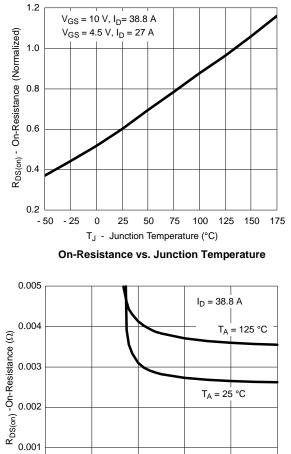
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

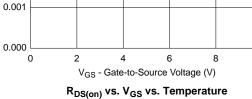


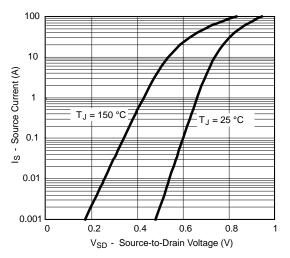




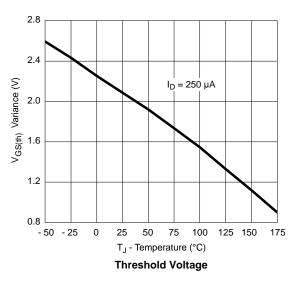
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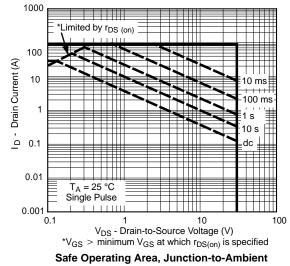






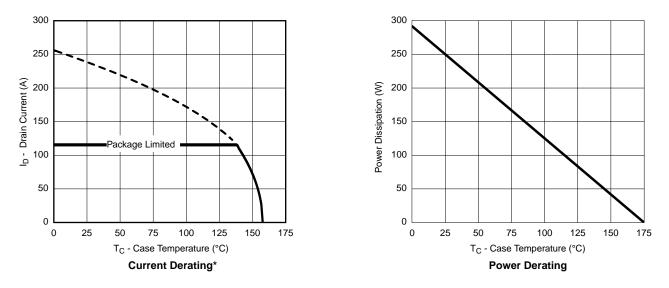






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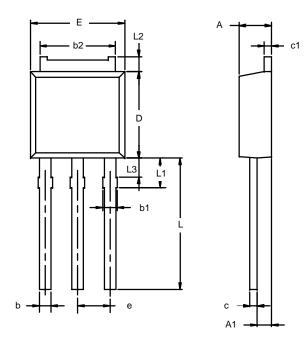
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

\*The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

Min   2.21   0.89   0.71   0.76	Max   2.38   1.14   0.89	Min 0.087 0.035	Max 0.094 0.045
0.89 0.71	1.14		
0.71		0.035	0.045
••••	0.89		
0.76		0.028	0.035
	1.14	0.030	0.045
5.23	5.43	0.206	0.214
0.46	0.58	0.018	0.023
0.46	0.58	0.018	0.023
5.97	6.22	0.235	0.245
6.48	6.73	0.255	0.265
2.28 BSC		0.090 BSC	
8.89	9.53	0.350	0.375
1.91	2.28	0.075	0.090
0.89	1.27	0.035	0.050
1.15	1.52	0.045	0.060
	0.46 5.97 6.48 2.28 8.89 1.91 0.89 1.15	0.46 0.58   5.97 6.22   6.48 6.73   2.28 BSC   8.89 9.53   1.91 2.28   0.89 1.27   1.15 1.52   46—Rev. E, 09-Jul-01	0.46 0.58 0.018   5.97 6.22 0.235   6.48 6.73 0.255   2.28 BSC 0.090   8.89 9.53 0.350   1.91 2.28 0.075   0.89 1.27 0.035   1.15 1.52 0.045

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